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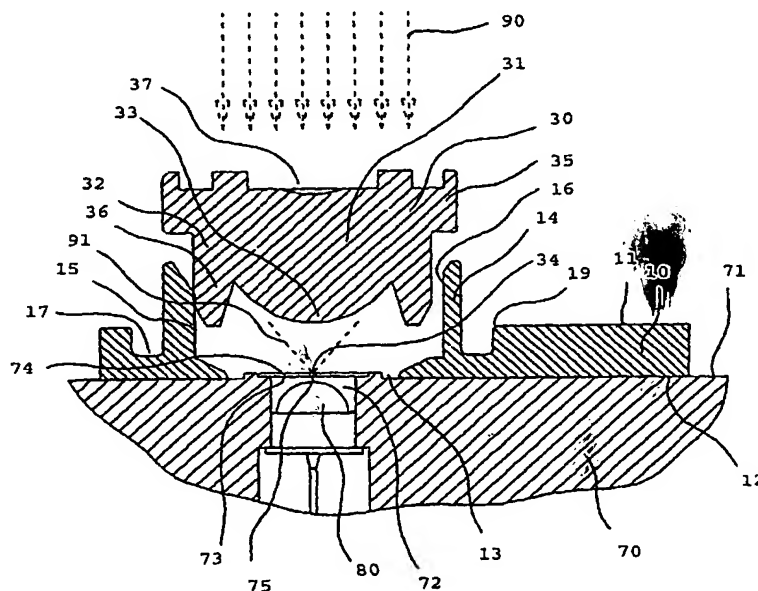
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(54) Title: METHOD FOR ASSEMBLING A CAMERA MODULE



(57) Abstract: A process for assembling a camera module comprises the following steps:- placing the substrate (10) on a positioning die (70);- irradiating the lens assembly (30) with parallel rays of light (90);- displacing a lens assembly (30) comprising the convex lens (33) in an axial direction;- measuring the light intensity of light passing through a spot hole (75) by means of a light sensor (80) being accommodated in the positioning die (70);- determining an optimal axial position of the lens assembly (30) on the basis of an obtained light intensity curve;- bringing the lens assembly (30) to the optimal axial position;- removing the positioning die (70); and- attaching an image sensor chip to a bottom surface (12) of the substrate (10).

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